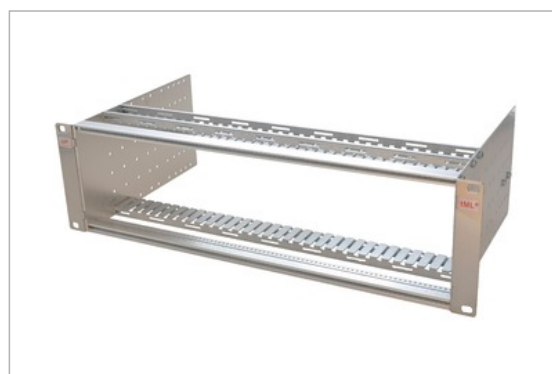


# tML® - Rack Mount Enclosure 19"/3U stainless steel for 17 x modules 5HP

## Description

tML® is a patented, modular cabling system consisting of the three key components module, trunk cable and rack mount enclosure. The system components are 100 percent manufactured, pre-assembled and tested in Germany. They enable plug-and-play installation on site – especially in data centres, but also in industrial environments – within the shortest possible time. Heart of the system are the rear MPO/MTP® and Telco connectors, which can be used to connect at least six or twelve ports at a time. Depending on the module configuration, transfer rates of up to 400G are currently possible with SR4. The fibre optic and TP modules can be used together in a module carrier with a very high port density. The tde offers its tML® cabling system as a proven tML® standard system and in the highly innovative variants tML® 12, tML® 24, tML® 32 and now tML® 24+ System for extreme scalability and very easy migration to higher transmission rates such as 40G, 100G, 200G, 400G and 800G and more.



The Rack Mount Enclosure 19"/3U is for the equip of up to 17 x tML® - modules 5HP with high component density.

## Technical Data

Box	Galvanized steel sheet with grounding screw
Frontplate	stainless steel
Inscription	by means of label strips
Equip	up to 17 modules, i.e. up to 102 RJ45-Ports or 2448 fibres with MPO/MTP® technology. The combination of different modules is possible.
Strain Relief	by means of cable straps at the means cross beam
Measures	19", 3U, depth 24cm
	QS-Managementsystem ISO 9001, ISO 14001 and TL 9000

Art.-No.	Description
TML-19/3HE-17	tML® - Rack Mount Enclosure 19"/3U stainless steel for 17 x modules 5HP
TML-19/3HE-17-S	tML® - Rack Mount Enclosures 19"/3U black for 17 x modules 5HP
TML-T-BLIND	tML® - Module Blind Plate 5HP for Rack Mount Enclosure 19"/3U
TML-T-BLIND-S	tML® - Module Blind Plate 5HP black for Rack Mount Enclosure 19"/3U